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July 2018

# SSA36 Surface Mount Schottky Barrier Rectifier

#### **Features**

- UL Flammability 94V-0 Classification
- MSL 1
- RoHS Compliant / Green Mold Compound



#### **Ordering Information**

Part Number	Top Mark	Package	Packing Method
SSA36	SSA36	DO-214AC (SMA)	Tape and Reel

#### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}\text{C}$  unless otherwise noted.

Symbol	Parameter	Value	Unit
V <sub>RRM</sub>	Recurrent Peak Reverse Voltage	60	V
V <sub>RMS</sub>	RMS Voltage	42	V
$V_{DC}$	DC Blocking Voltage	60	V
I <sub>F(AV)</sub>	Average Forward Current at T <sub>L</sub> = 75°C	3	Α
I <sub>FSM</sub>	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load	80	А
T <sub>J</sub>	Operating Junction Temperature Range	-55 to +150	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to +150	°C

#### Thermal Characteristics(1)

Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Unit
ΨJL	Typical Thermal Characteristics, Junction-to-Lead <sup>(2)</sup>	30	°C/W
$R_{\theta JA}$	Typical Thermal Resistance, Junction-to-Ambient	180	°C/W

#### Note:

- 1. Per JESD51-3 recommended thermal test board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.
- 2. Thermocouple soldered at cathode lead.

#### **Electrical Characteristics**

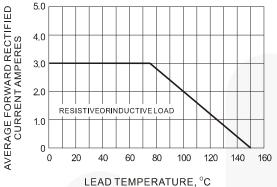
Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V <sub>F</sub>	Forward Voltage <sup>(3)</sup>	I <sub>F</sub> = 3.0 A			0.75	V
./	DC Reverse Current	V <sub>R</sub> = 60 V			0.1	mA
IR		$V_R = 60 \text{ V}, T_A = 100^{\circ}\text{C}$			20	
T <sub>rr</sub>	Reverse Recovery Time	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, I_{rr} = 0.25 \text{ A}$		10.74		ns

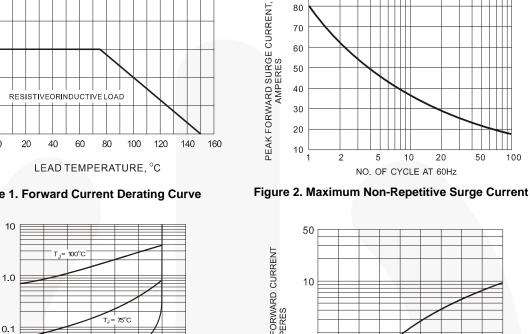
#### Note:

3. Pulse test with Pulse width = 300  $\mu$ s, 1% duty cycle.

#### **Typical Performance Characteristics**



**Figure 1. Forward Current Derating Curve** 



90

80

70 60

40

30

.001 60 80 100 120 PERCENT OF INSTANTANEOUS REVERSE VOLTAGE,(%)

Figure 3. Typical Reverse Characteristic

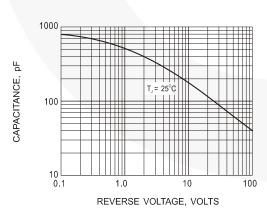
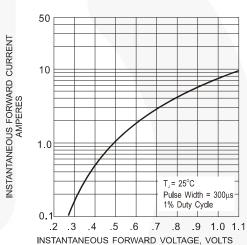


Figure 5. Typical Junction Capacitance



10

50

100

Figure 4. Typical Instantaneous Forward Characteristics

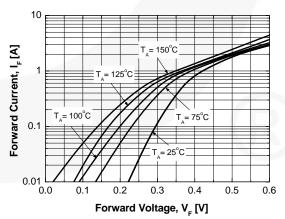


Figure 6. Typical Forward Characteristics

INSTANTANEOUS REVERSE CURRENT, mA

0.01

#### **Physical Dimensions**

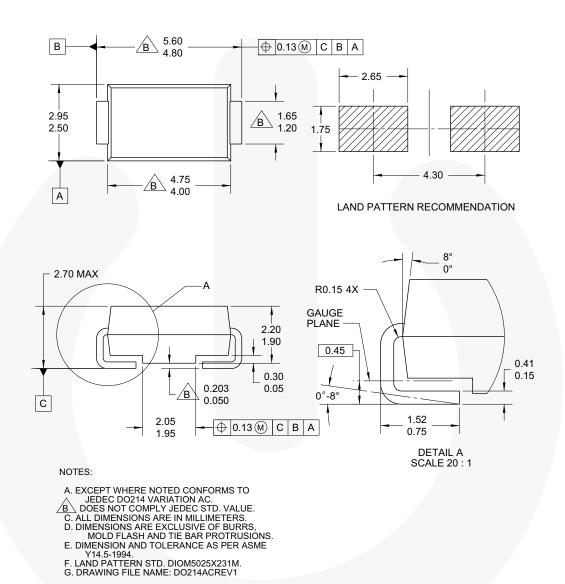


Figure 7. 2-LEAD, SMA, JEDEC DO-214, VARIATION AC





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Definition of Terms				
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
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